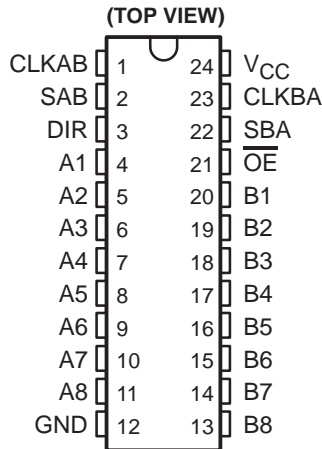


SN54LVC646A, SN74LVC646A OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

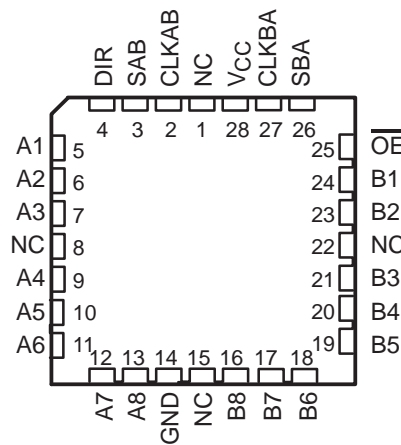
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- Operate From 1.65 V to 3.6 V
- Inputs Accept Voltages to 5.5 V
- Max t_{pd} of 7.4 ns at 3.3 V
- Typical V_{OLP} (Output Ground Bounce) <0.8 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- Typical V_{OHV} (Output V_{OH} Undershoot) >2 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- Support Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V_{CC})
- I_{off} Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

SN54LVC646A . . . JT OR W PACKAGE
SN74LVC646A . . . DB, DW, NS, OR PW PACKAGE



SN54LVC646A . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

description/ordering information

The SN54LVC646A octal bus transceiver and register is designed for 2.7-V to 3.6-V V_{CC} operation, and the SN74LVC646A octal bus transceiver and register is designed for 1.65-V to 3.6-V V_{CC} operation.

ORDERING INFORMATION

T_A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	SOIC – DW	Tube of 25	SN74LVC646ADW	LVC646A
		Reel of 2000	SN74LVC646ADWR	
	SOP – NS	Reel of 2000	SN74LVC646ANSR	LVC646A
	SSOP – DB	Reel of 2000	SN74LVC646ADBR	LC646A
	TSSOP – PW	Tube of 60	SN74LVC646APW	LC646A
		Reel of 2000	SN74LVC646APWR	
		Reel of 250	SN74LVC646APWT	
–55°C to 125°C	CDIP – JT	Tube of 15	SNJ54LVC646AJT	SNJ54LVC646AJT
	CFP – W	Tube of 85	SNJ54LVC646AW	SNJ54LVC646AW
	LCCC – FK	Tube of 42	SNJ54LVC646AFK	SNJ54LVC646AFK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

SN54LVC646A, SN74LVC646A

OCTAL BUS TRANSCEIVERS AND REGISTERS

WITH 3-STATE OUTPUTS

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description/ordering information (continued)

These devices consist of bus-transceiver circuits, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the input bus or from the internal registers. Data on the A or B bus is clocked into the registers on the low-to-high transition of the appropriate clock (CLKAB or CLKBA) input. Figure 1 illustrates the four fundamental bus-management functions that are performed with the 'LVC646A devices.

Output-enable (\overline{OE}) and direction-control (DIR) inputs control the transceiver functions. In the transceiver mode, data present at the high-impedance port is stored in either register or in both.

The select-control (SAB and SBA) inputs can multiplex stored and real-time (transparent mode) data. DIR determines which bus receives data when \overline{OE} is low. In the isolation mode (\overline{OE} high), A data is stored in one register and B data can be stored in the other register.

When an output function is disabled, the input function still is enabled and can be used to store and transmit data. Only one of the two buses, A or B, can be driven at a time.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.

These devices are fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

FUNCTION TABLE

INPUTS						DATA I/O		OPERATION OR FUNCTION
\overline{OE}	DIR	CLKAB	CLKBA	SAB	SBA	A1–A8	B1–B8	
X	X	↑	X	X	X	Input	Unspecified†	Store A, B unspecified†
X	X	X	↑	X	X	Unspecified†	Input	Store B, A unspecified†
H	X	↑	↑	X	X	Input	Input	Store A and B data
H	X	H or L	H or L	X	X	Input disabled	Input disabled	Isolation, hold storage
L	L	X	X	X	L	Output	Input	Real-time B data to A bus
L	L	X	H or L	X	H	Output	Input	Stored B data to A bus
L	H	X	X	L	X	Input	Output	Real-time A data to B bus
L	H	H or L	X	H	X	Input	Output	Stored A data to B bus

† The data-output functions can be enabled or disabled by various signals at \overline{OE} and DIR. Data-input functions always are enabled; i.e., data at the bus terminals is stored on every low-to-high transition of the clock inputs.

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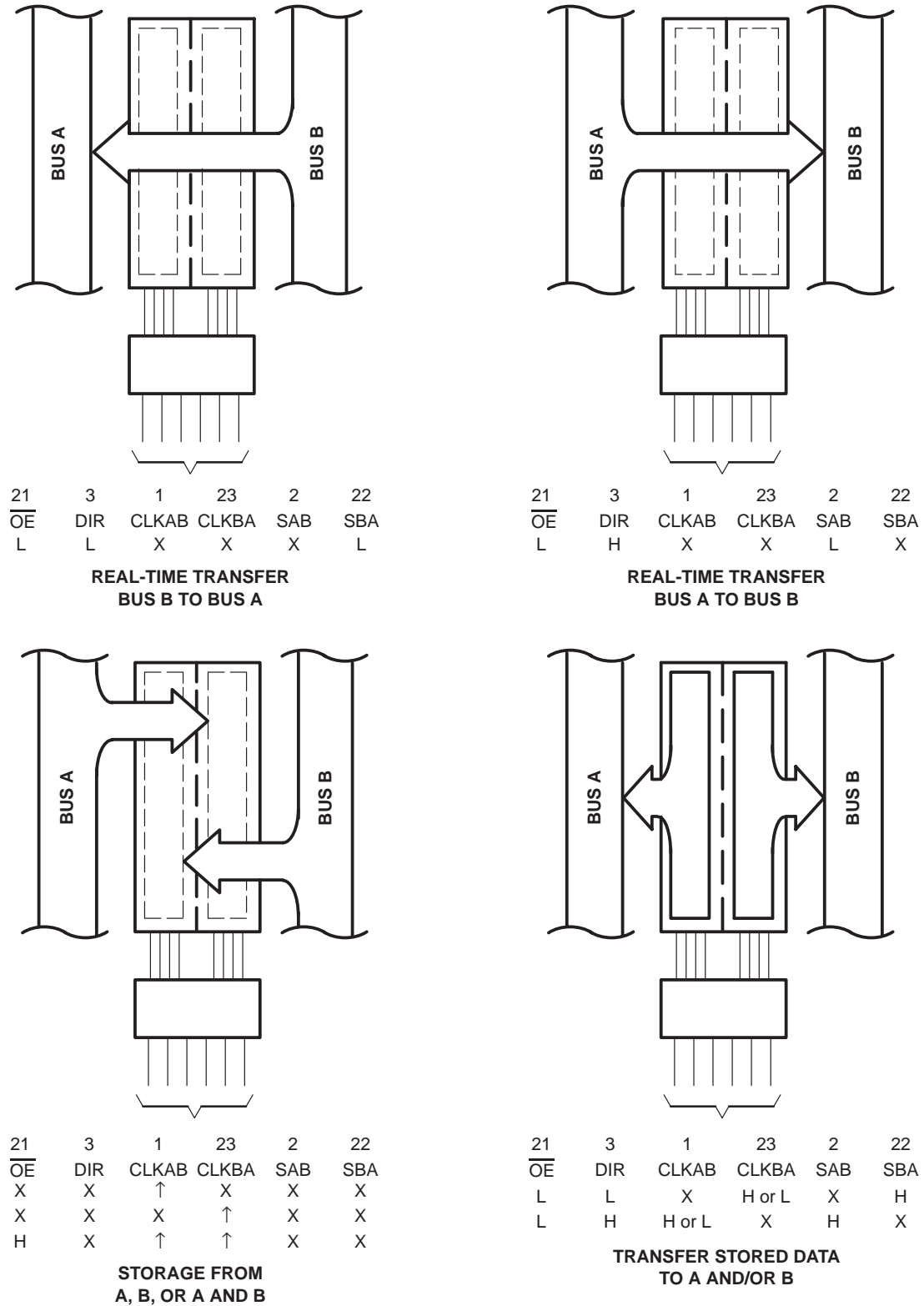


Figure 1. Bus-Management Functions

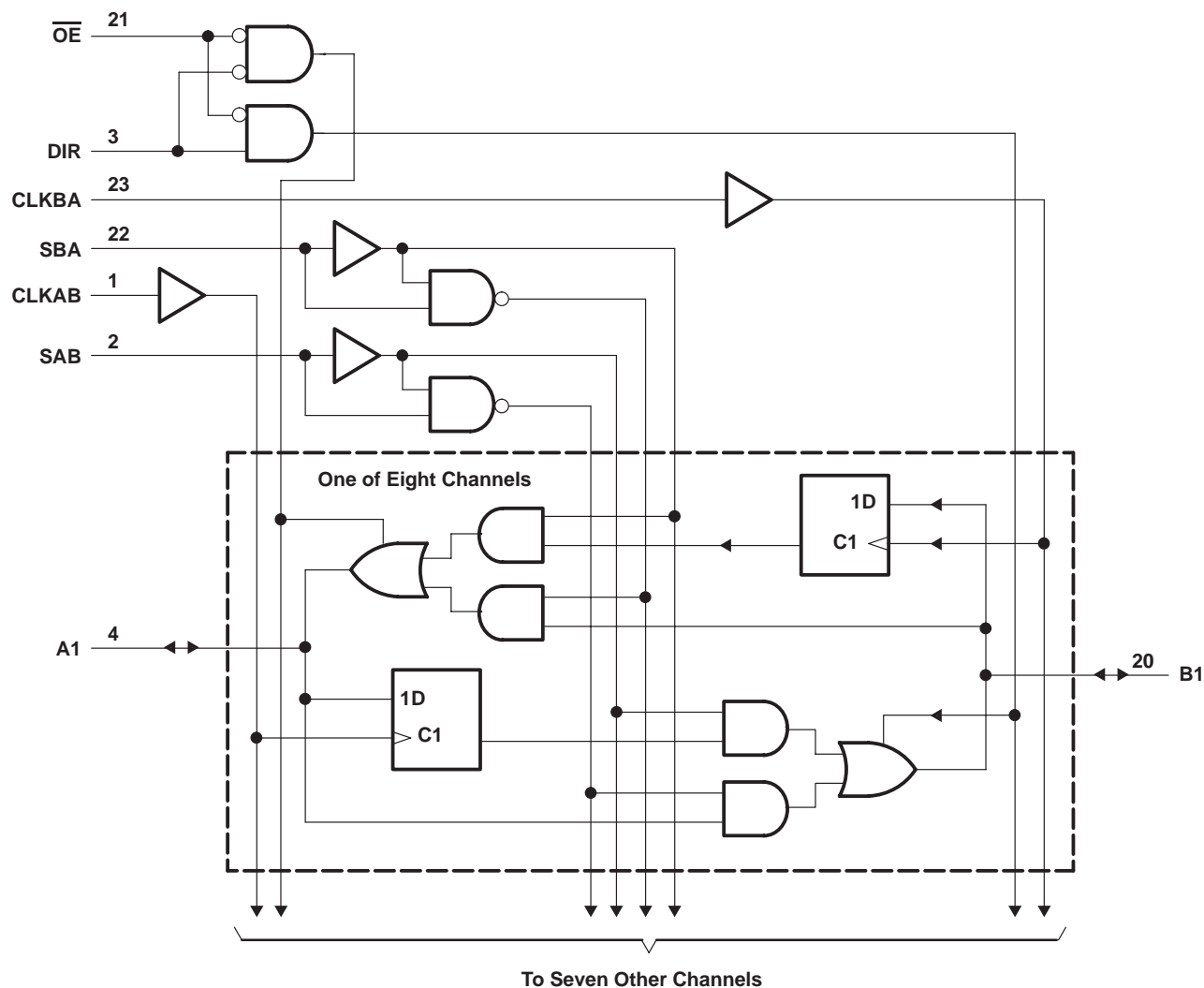
SN54LVC646A, SN74LVC646A

OCTAL BUS TRANSCEIVERS AND REGISTERS

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logic diagram (positive logic)



Pin numbers shown are for the DB, DW, JT, NS, PW, and W packages.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	–0.5 V to 6.5 V
Input voltage range, V_I (see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high-impedance or power-off state, V_O (see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high or low state, V_O (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	–50 mA
Output clamp current, I_{OK} ($V_O < 0$)	–50 mA
Continuous output current, I_O	±50 mA
Continuous current through V_{CC} or GND	±100 mA
Package thermal impedance, θ_{JA} (see Note 3): DB package	63°C/W
DW package	46°C/W
NS package	65°C/W
PW package	88°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The value of V_{CC} is provided in the recommended operating conditions table.
3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 4)

		SN54LVC646A		SN74LVC646A		UNIT
		MIN	MAX	MIN	MAX	
V_{CC} Supply voltage	Operating	2	3.6	1.65	3.6	V
	Data retention only	1.5		1.5		
V_{IH} High-level input voltage	$V_{CC} = 1.65$ V to 1.95 V			$0.65 \times V_{CC}$		V
	$V_{CC} = 2.3$ V to 2.7 V			1.7		
	$V_{CC} = 2.7$ V to 3.6 V	2		2		
V_{IL} Low-level input voltage	$V_{CC} = 1.65$ V to 1.95 V			$0.35 \times V_{CC}$		V
	$V_{CC} = 2.3$ V to 2.7 V			0.7		
	$V_{CC} = 2.7$ V to 3.6 V		0.8	0.8		
V_I Input voltage		0	5.5	0	5.5	V
V_O Output voltage	High or low state	0	V_{CC}	0	V_{CC}	V
	3-state	0	5.5	0	5.5	
I_{OH} High-level output current	$V_{CC} = 1.65$ V				–4	mA
	$V_{CC} = 2.3$ V				–8	
	$V_{CC} = 2.7$ V		–12		–12	
	$V_{CC} = 3$ V		–24		–24	
I_{OL} Low-level output current	$V_{CC} = 1.65$ V				4	mA
	$V_{CC} = 2.3$ V				8	
	$V_{CC} = 2.7$ V		12		12	
	$V_{CC} = 3$ V		24		24	
$\Delta t/\Delta v$ Input transition rise or fall rate			10		10	ns/V
T_A Operating free-air temperature		–55	125	–40	85	°C

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



SN54LVC646A, SN74LVC646A

OCTAL BUS TRANSCEIVERS AND REGISTERS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V _{CC}	SN54LVC646A			SN74LVC646A			UNIT	
				MIN	TYP†	MAX	MIN	TYP†	MAX		
V _{OH}		I _{OH} = -100 μA	1.65 V to 3.6 V				V _{CC} -0.2			V	
			2.7 V to 3.6 V	V _{CC} -0.2							
		I _{OH} = -4 mA	1.65 V				1.2				
		I _{OH} = -8 mA	2.3 V				1.7				
		I _{OH} = -12 mA	2.7 V	2.2			2.2				
			3 V	2.4			2.4				
		I _{OH} = -24 mA	3 V	2.2			2.2				
V _{OL}		I _{OL} = 100 μA	1.65 V to 3.6 V				0.2			V	
			2.7 V to 3.6 V	0.2							
		I _{OL} = 4 mA	1.65 V				0.45				
		I _{OL} = 8 mA	2.3 V				0.7				
		I _{OL} = 12 mA	2.7 V	0.4			0.4				
		I _{OL} = 24 mA	3 V	0.55			0.55				
I _I	Control inputs	V _I = 0 to 5.5 V	3.6 V	±5			±5			μA	
I _{off}		V _I or V _O = 5.5 V	0				±10			μA	
I _{OZ} ‡		V _O = 0 to 5.5 V	3.6 V	±15			±10			μA	
I _{CC}		V _I = V _{CC} or GND	I _O = 0	3.6 V	10			10			μA
		3.6 V ≤ V _I ≤ 5.5 V§			10			10			
ΔI _{CC}		One input at V _{CC} - 0.6 V, Other inputs at V _{CC} or GND	2.7 V to 3.6 V	500			500			μA	
C _i	Control inputs	V _I = V _{CC} or GND	3.3 V	4.5			4.5			pF	
C _{io}	A or B ports	V _O = V _{CC} or GND	3.3 V	7.5			7.5			pF	

† All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

‡ For I/O ports, the parameter I_{OZ} includes the input leakage current.

§ This applies in the disabled state only.

timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 2)

		SN54LVC646A				UNIT
		V _{CC} = 2.7 V		V _{CC} = 3.3 V ± 0.3 V		
		MIN	MAX	MIN	MAX	
f _{clock}	Clock frequency	150		150		MHz
t _w	Pulse duration	3.3		3.3		ns
t _{su}	Setup time, data before CLK↑	1.6		1.5		ns
t _h	Hold time, data after CLK↑	1.7		1.7		ns



SN54LVC646A, SN74LVC646A

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timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 2)

		SN74LVC646A								UNIT
		$V_{CC} = 1.8\text{ V}$ $\pm 0.15\text{ V}$		$V_{CC} = 2.5\text{ V}$ $\pm 0.2\text{ V}$		$V_{CC} = 2.7\text{ V}$		$V_{CC} = 3.3\text{ V}$ $\pm 0.3\text{ V}$		
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f _{clock}	Clock frequency	†		†		150		150		MHz
t _w	Pulse duration	†		†		3.3		3.3		ns
t _{su}	Setup time, data before CLK↑	†		†		1.6		1.5		ns
t _h	Hold time, data after CLK↑	†		†		1.7		1.7		ns

† This information was not available at the time of publication.

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54LVC646A				UNIT
			V _{CC} = 2.7 V		V _{CC} = 3.3 V ± 0.3 V		
			MIN	MAX	MIN	MAX	
f _{max}			150		150		MHz
t _{pd}	A or B	B or A	7.9		1	7.4	ns
	CLK	A or B	8.8		1	8.4	
	SBA or SAB		9.9		1	8.6	
t _{en}	$\overline{\text{OE}}$	A	10.2		1	8.2	ns
t _{dis}	$\overline{\text{OE}}$	A	8.9		1	7.5	ns
t _{en}	DIR	B	10.4		1	8.3	ns
t _{dis}	DIR	B	8.7		1	7.9	ns

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN74LVC646A								UNIT
			V _{CC} = 1.8 V ± 0.15 V		V _{CC} = 2.5 V ± 0.2 V		V _{CC} = 2.7 V		V _{CC} = 3.3 V ± 0.3 V		
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f _{max}			†		†		150		150		MHz
t _{pd}	A or B	B or A	†	†	†	†	7.9	1.4	7.4	ns	
	CLK	A or B	†	†	†	†	8.8	1.3	8.4		
	SBA or SAB		†	†	†	†	9.9	1.4	8.6		
t _{en}	$\overline{\text{OE}}$	A	†	†	†	†	10.2	1	8.2	ns	
t _{dis}	$\overline{\text{OE}}$	A	†	†	†	†	8.9	1	7.5	ns	
t _{en}	DIR	B	†	†	†	†	10.4	1.2	8.3	ns	
t _{dis}	DIR	B	†	†	†	†	8.7	1.1	7.9	ns	

† This information was not available at the time of publication.



SN54LVC646A, SN74LVC646A

OCTAL BUS TRANSCEIVERS AND REGISTERS

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operating characteristics, $T_A = 25^\circ\text{C}$

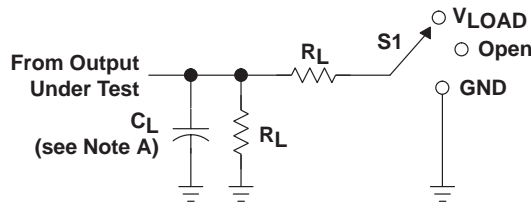
PARAMETER		TEST CONDITIONS	$V_{CC} = 1.8\text{ V}$	$V_{CC} = 2.5\text{ V}$	$V_{CC} = 3.3\text{ V}$	UNIT
			TYP	TYP	TYP	
C_{pd} Power dissipation capacitance per transceiver	Outputs enabled	$f = 10\text{ MHz}$	†	†	75	pF
	Outputs disabled		†	†	9	

† This information was not available at the time of publication.

SN54LVC646A, SN74LVC646A OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

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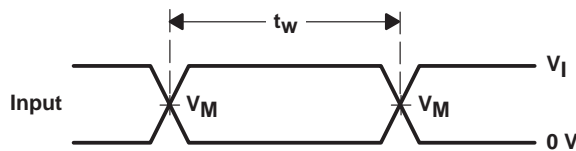
PARAMETER MEASUREMENT INFORMATION



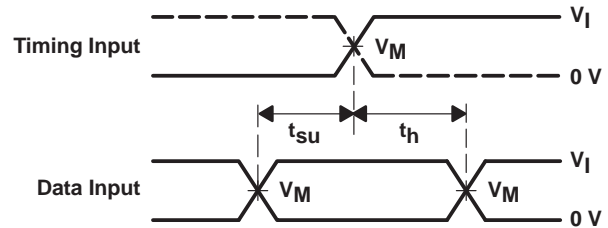
LOAD CIRCUIT

TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	V_{LOAD}
t_{PHZ}/t_{PZH}	GND

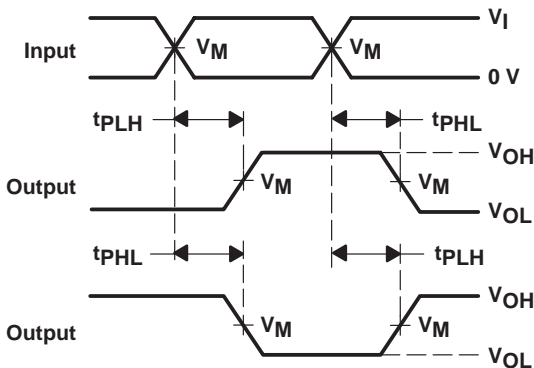
V_{CC}	INPUTS		V_M	V_{LOAD}	C_L	R_L	V_{Δ}
	V_I	t_r/t_f					
$1.8\text{ V} \pm 0.15\text{ V}$	V_{CC}	$\leq 2\text{ ns}$	$V_{CC}/2$	$2 \times V_{CC}$	30 pF	1 k Ω	0.15 V
$2.5\text{ V} \pm 0.2\text{ V}$	V_{CC}	$\leq 2\text{ ns}$	$V_{CC}/2$	$2 \times V_{CC}$	30 pF	500 Ω	0.15 V
2.7 V	2.7 V	$\leq 2.5\text{ ns}$	1.5 V	6 V	50 pF	500 Ω	0.3 V
$3.3\text{ V} \pm 0.3\text{ V}$	2.7 V	$\leq 2.5\text{ ns}$	1.5 V	6 V	50 pF	500 Ω	0.3 V



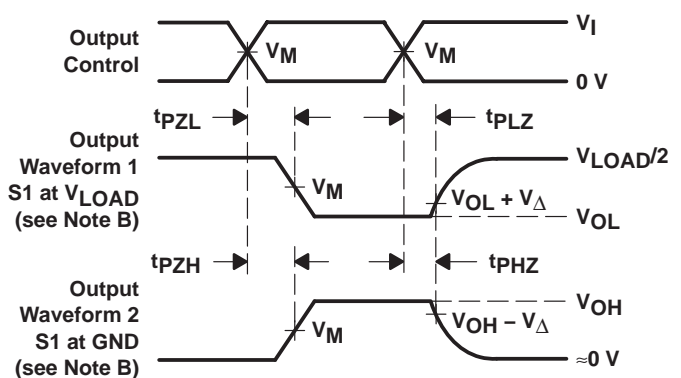
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

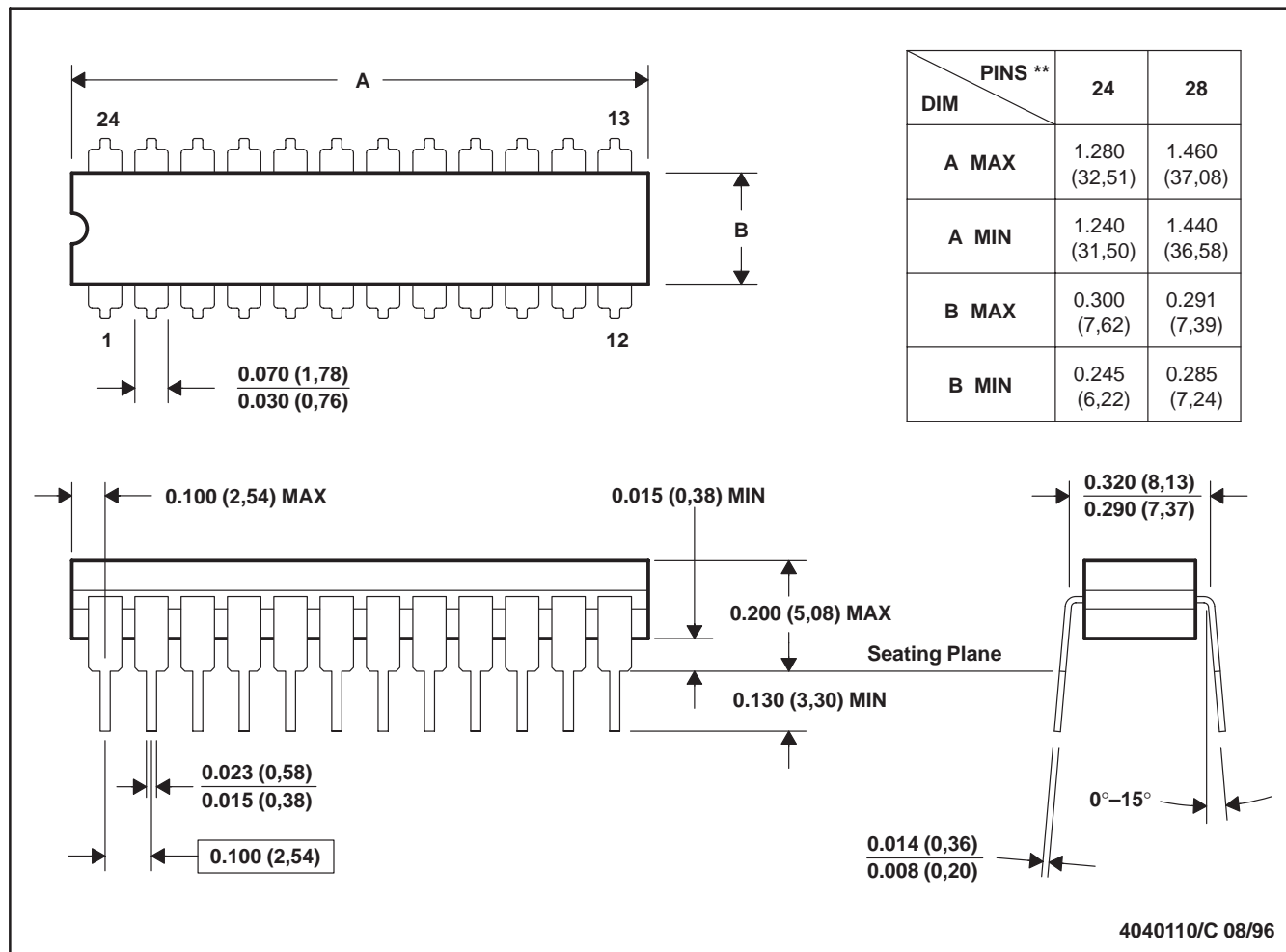
- NOTES:
- C_L includes probe and jig capacitance.
 - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_O = 50\ \Omega$.
 - The outputs are measured one at a time with one transition per measurement.
 - t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - t_{PZL} and t_{PZH} are the same as t_{en} .
 - t_{PLH} and t_{PHL} are the same as t_{pd} .
 - All parameters and waveforms are not applicable to all devices.

Figure 2. Load Circuit and Voltage Waveforms

JT (R-GDIP-T**)

CERAMIC DUAL-IN-LINE

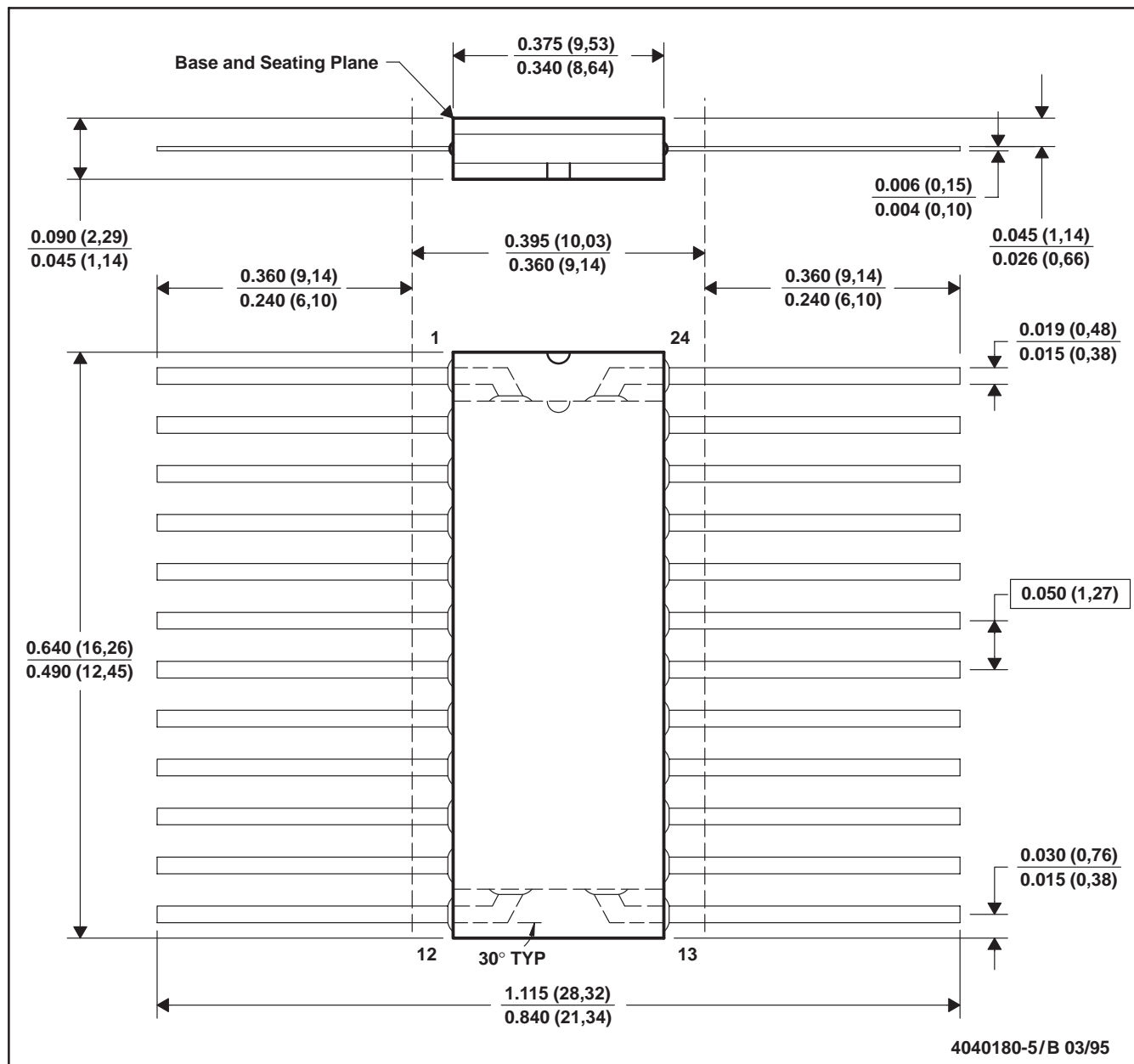
24 LEADS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. This package can be hermetically sealed with a ceramic lid using glass frit.
 D. Index point is provided on cap for terminal identification.
 E. Falls within MIL STD 1835 GDIP3-T24, GDIP4-T28, and JEDEC MO-058 AA, MO-058 AB

W (R-GDFP-F24)

CERAMIC DUAL FLATPACK

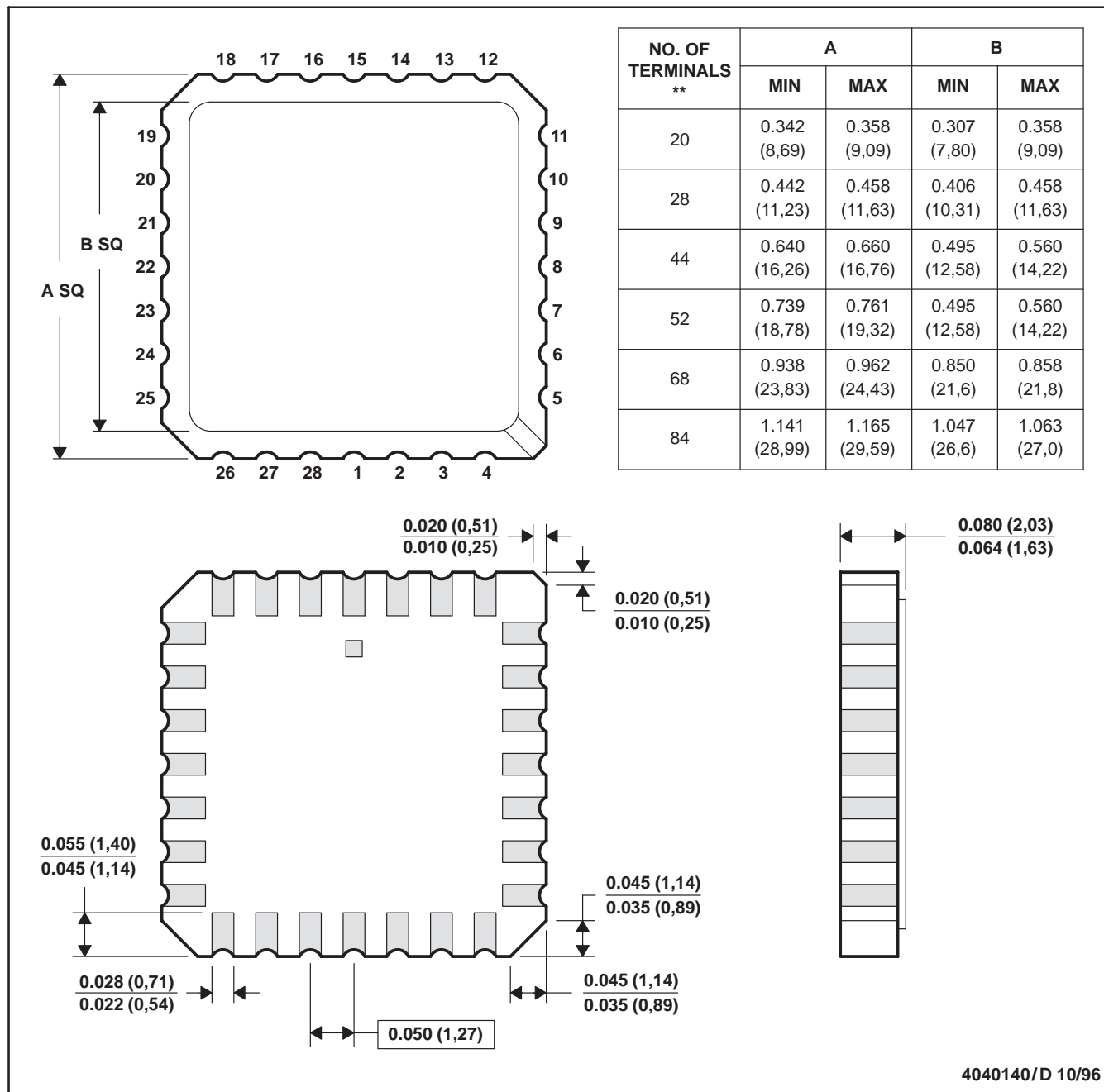


- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Falls within MIL-STD-1835 GDFP2-F24 and JEDEC MO-070AD
 - E. Index point is provided on cap for terminal identification only.

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN

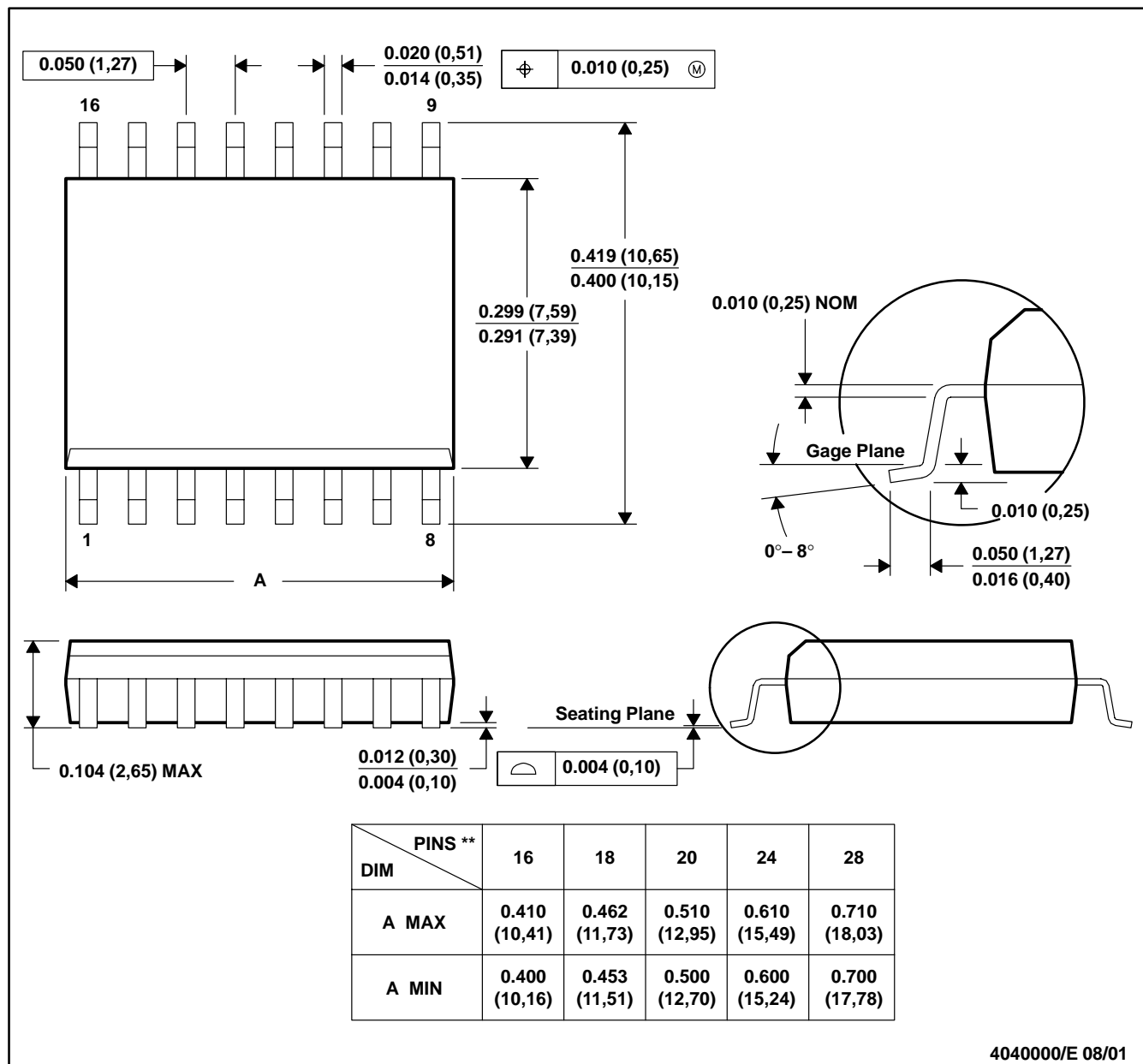


- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package can be hermetically sealed with a metal lid.
 - The terminals are gold plated.
 - Falls within JEDEC MS-004

DW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

16 PINS SHOWN



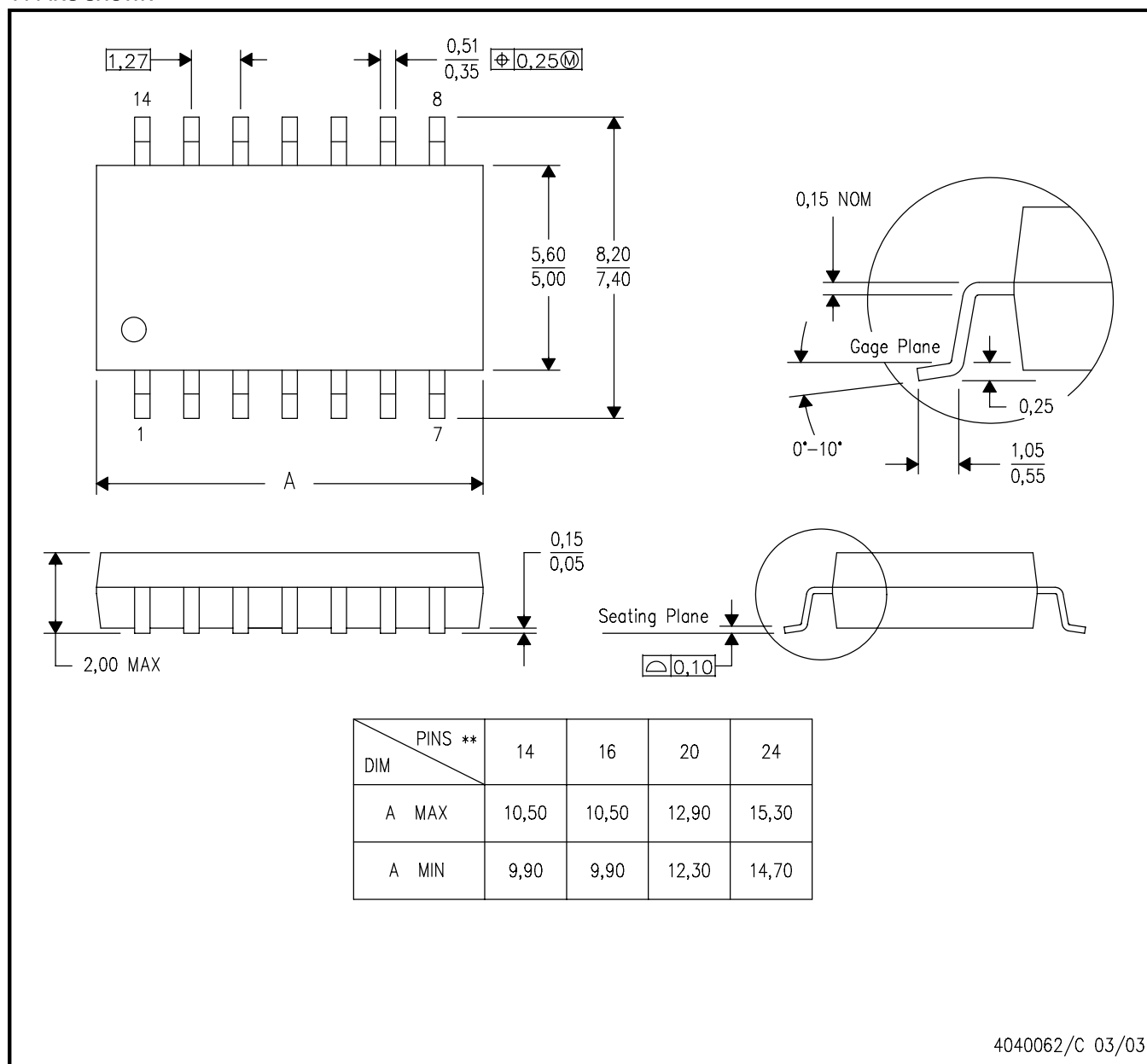
- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 D. Falls within JEDEC MS-013

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN

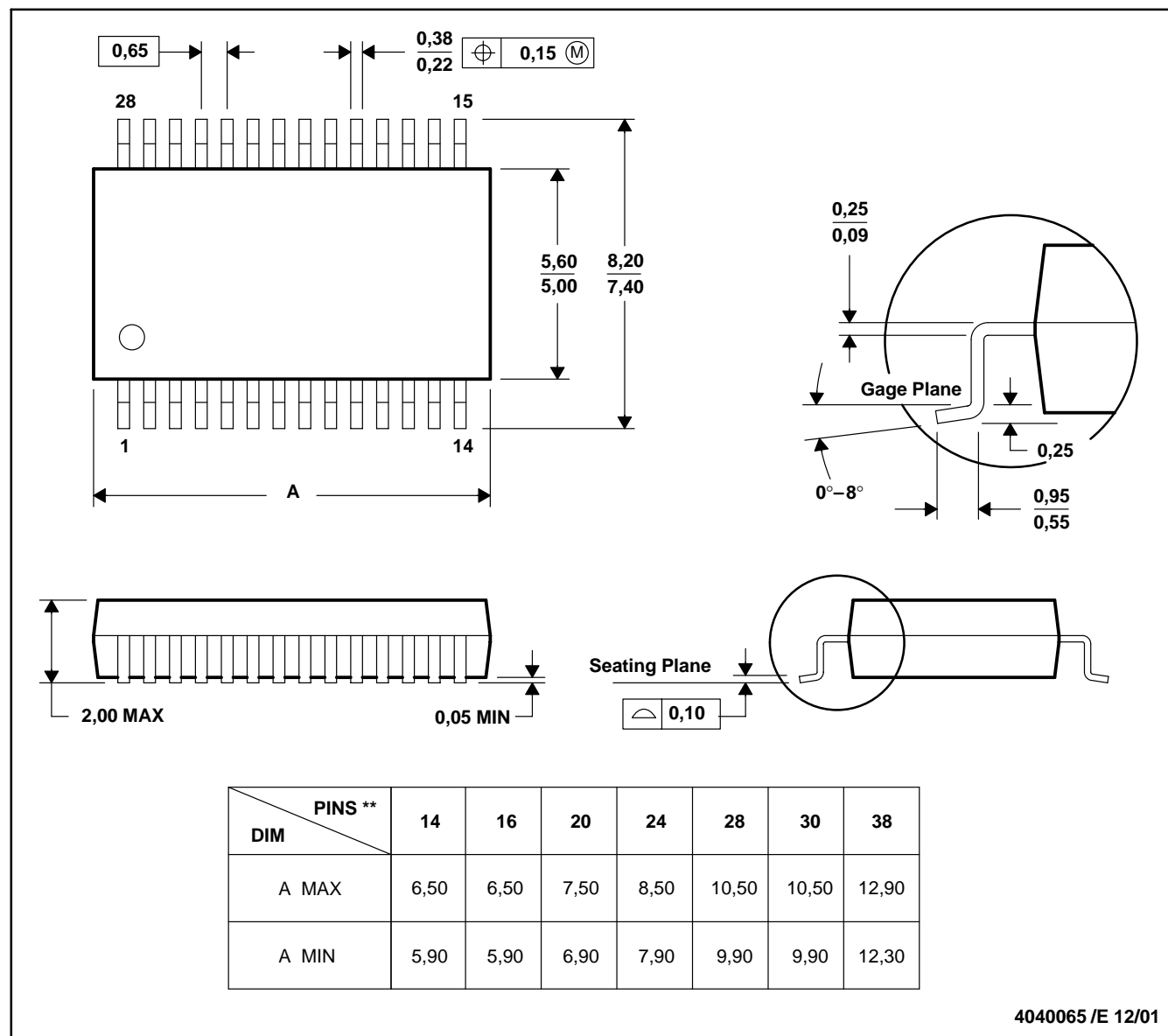


- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN

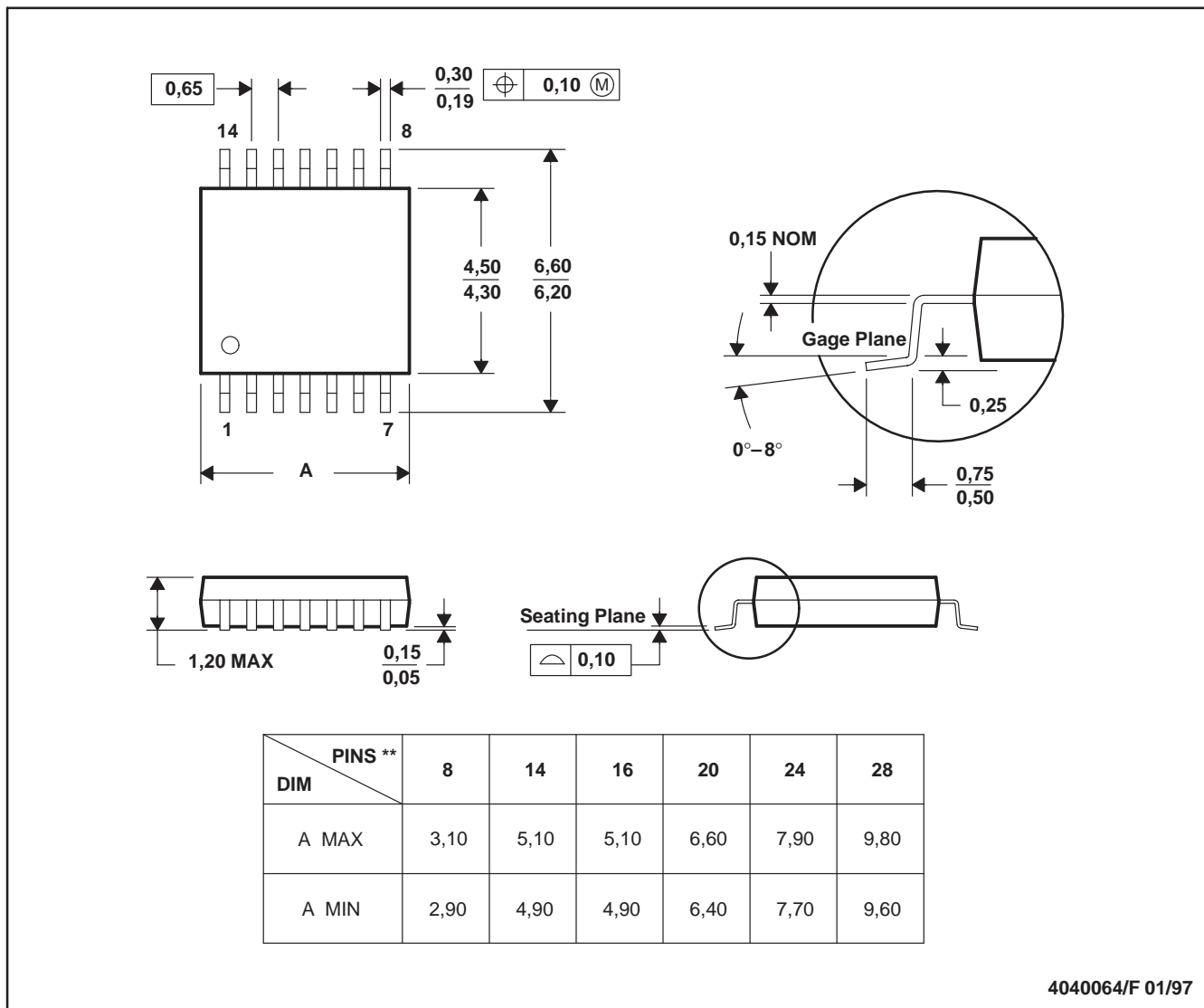


- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-150

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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